



**BSI Standards Publication**

## **Field Device Integration (FDI®)**

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Part 6-200: Technology Mapping — HTML5

## National foreword

This British Standard is the UK implementation of EN IEC 62769-6-200:2023. It is identical to IEC 62769-6-200:2023.

The UK participation in its preparation was entrusted to Technical Committee GEL/65/5, Devices and integration in enterprise systems.

A list of organizations represented on this committee can be obtained on request to its committee manager.

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English Version

Field Device Integration (FDI®) - Part 6-200: Technology  
Mapping - HTML5  
(IEC 62769-6-200:2023)

Intégration des appareils de terrain (FDI®) - Partie 6-200:  
Mapping de technologies - HTML5  
(IEC 62769-6-200:2023)

Feldgeräteintegration (FDI®) - Teil 6-200: FDI-  
Technologieabbildungen - HTML5  
(IEC 62769-6-200:2023)

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European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

## **European foreword**

The text of document 65E/870/CDV, future edition 1 of IEC 62769-6-200, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-6-200:2023.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2024-02-19 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2026-05-19 document have to be withdrawn

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## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cencenelec.eu](http://www.cencenelec.eu).

| <u>Publication</u> | <u>Year</u> | <u>Title</u>                                                                   | <u>EN/HD</u>   | <u>Year</u> |
|--------------------|-------------|--------------------------------------------------------------------------------|----------------|-------------|
| FCG TS10099        | -           | Field Device Integration (FDI®) – Technology Management                        | -              | -           |
| IEC 62769-1        | 2021        | Field Device Integration (FDI) - Part 1: Overview                              | EN IEC 62769-1 | 2021        |
| IEC 62769-2        | 2021        | Field Device Integration (FDI) - Part 2: FDI Client                            | EN IEC 62769-2 | 2021        |
| IEC 62769-4        | -           | Field Device Integration (FDI®) - Part 4: FDI Packages                         | -              | -           |
| IEC 62769-6-100    | -           | Field Device Integration (FDI®) - Part 6-100: Technology Mapping - .Net        | -              | -           |
| W3C HTML5.0        | -           | W3C Recommendation HTML5 - A vocabulary and associated APIs for HTML and XHTML | -              | -           |

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## FIELD DEVICE INTEGRATION (FDI®) –

## Part 6-200: Technology Mapping – HTML5

## FOREWORD

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IEC c0 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

The text of this International Standard is based on the following documents:

| Draft       | Report on voting |
|-------------|------------------|
| 65E/870/CDV | 65E/926/RVC      |

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/publications](http://www.iec.ch/publications).

A list of all parts in the IEC 62769 series, published under the general title *Field device integration (FDI®)*, can be found on the IEC website.

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